

Features

- Surface Mount DIL-Package
- 16 Standard Models
- Regulated Output Voltage
- I/O-isolation 1'000 VDC
- Very low Output Noise
- Indefinite Short-Circuit Protection
- High Accuracy of Pin Co-Planarity
- High Reliability, MTBF >800'000 h
- Reflow Soldering to
CECC 00 802, Issue 2
- 2 Year Product Warranty



The TES 2 converter series is intended for all applications where PCB's are assembled on an automated SMD production line. The small size DIL-package and the light weight allows easy handling by pick-and-place machines.

They offer a 1000 VDC I/O-isolation and internal filters to reduce reflected input ripple current and to guarantee low output noise. This product series provides an economical solution for many cost critical applications in industrial and consumer electronics.

| Models | | | | |
|--|---------------|---|--|------------------------------|
| Ordercode | Input voltage | Output voltage | Output current max. | Efficiency typ. |
| TES 2-0511 TES 2-0512 TES 2-0522 TES 2-0523 | 5 VDC ±10% | 5 VDC 12 VDC ± 12 VDC ± 15 VDC | 400 mA 165 mA ± 85 mA ± 65 mA | 60 % 60 % 60 % 60 % |
| TES 2-1211 TES 2-1212 TES 2-1222 TES 2-1223 | 12 VDC ±10% | 5 VDC 12 VDC ± 12 VDC ± 15 VDC | 400 mA 165 mA ± 85 mA ± 65 mA | 60 % 60 % 60 % 60 % |
| TES 2-2411 TES 2-2412 TES 2-2422 TES 2-2423 | 24 VDC ±10% | 5 VDC 12 VDC ± 12 VDC ± 15 VDC | 400 mA 165 mA ± 85 mA ± 65 mA | 60 % 60 % 60 % 60 % |
| TES 2-4811 TES 2-4812 TES 2-4822 TES 2-4823 | 48 VDC ±10% | 5 VDC 12 VDC ± 12 VDC ± 15 VDC | 400 mA 165 mA ± 85 mA ± 65 mA | 60 % 60 % 60 % 60 % |

Input Specifications

| | | |
|----------------------------------|---|---|
| Input current no load /full load | 5 Vin models 12 Vin models 24 Vin models 48 Vin models | 80 mA / 665 mA typ. 35 mA / 280 mA typ. 17 mA / 140 mA typ. 10 mA / 70 mA typ. |
| Surge voltage (1 sec. max.) | 5 Vin models 12 Vin models 24 Vin models 48 Vin models | 7.5 VDC max. 15 VDC max. 30 VDC max. 55 VDC max. |
| Reverse voltage protection | | 500 mA max. |
| Input Filter | | Pi-Filter |

Output Specifications

| | | |
|-------------------------------------|---|--|
| Voltage set accuracy | | ± 3 % |
| Regulation | – Input variation Vin min. to Vin max. – Load variation 10 – 100 % – single output models – dual output models balanced load | ± 0.3 % max. ± 0.5 % max. ± 3 % max. |
| Ripple and noise (20 MHz Bandwidth) | | 50 mVpk-pk max. |
| Temperature coefficient | | ± 0.02 % / °C |
| Output current limitation | | >120 % of Iout max., constant current |
| Short circuit protection | | indefinite (automatic recovery) |
| Capacitive load | – single output models – dual output models | 470 µF max. 220 µF max. |

General Specifications

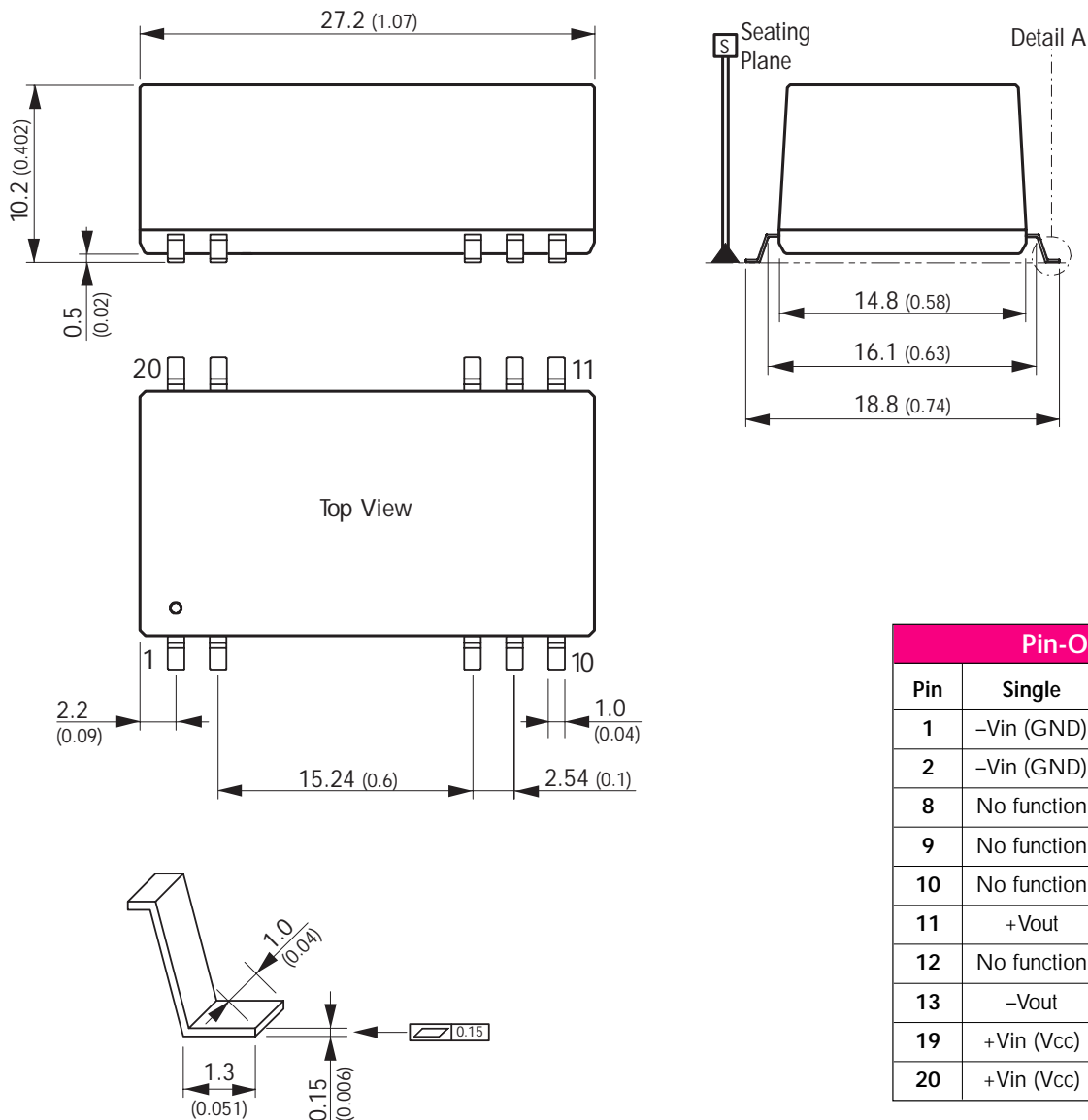
| | | |
|---|--|---|
| Temperature ranges | – Operating – Case temperature – Storage | – 40 °C ... + 60 °C (no derating) + 95 °C max. – 40 °C ... + 125 °C |
| Derating | | 2.9% / °C above 60 °C |
| Humidity (non condensing) | | 95 % rel H max. |
| Reliability, calculated MTBF (MIL-HDBK-217 E) | | >800'000h @ + 25 °C |
| Isolation voltage | Input/Output | 1'000VDC |
| Isolation capacity | Input/Output | 100 pF typ. |
| Isolation resistance | Input/Output (500 VDC) | > 1'000 M Ohm |
| Switching frequency | | 80 KHz typ. (depending on load) |

All specifications valid at nominal input voltage, full load and +25°C after warm-up time unless otherwise stated.

Physical Specifications

| | |
|--------------------------|--|
| Case material | non conductive black plastic |
| Weight | 10 g (0.35 oz) |
| Reflow soldering profile | Peak temp. 230°C (10 sec max.) 185°C for 90 sec max. Convection reflow solder process is recommended |

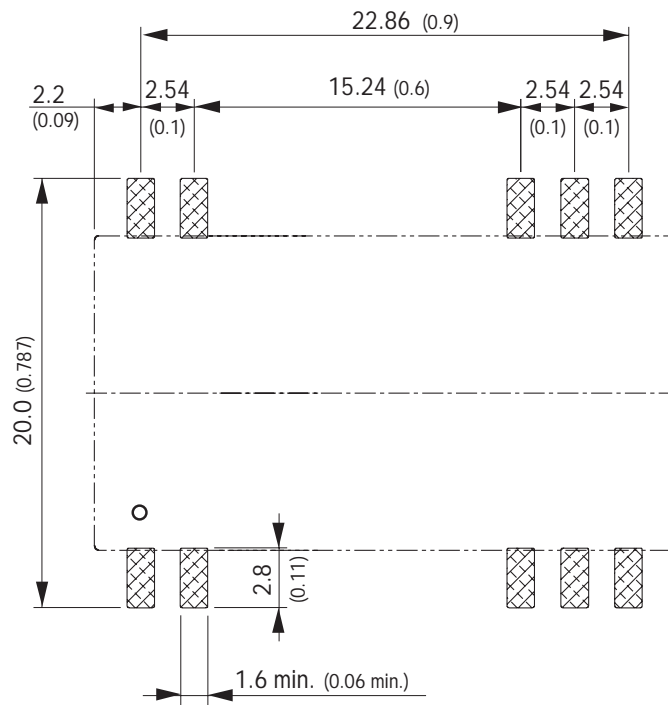
Outline Dimensions mm (inches)



| Pin-Out | | |
|---------|-------------|-------------|
| Pin | Single | Dual |
| 1 | -Vin (GND) | -Vin (GND) |
| 2 | -Vin (GND) | -Vin (GND) |
| 8 | No function | Common |
| 9 | No function | No function |
| 10 | No function | -Vout |
| 11 | +Vout | +Vout |
| 12 | No function | No function |
| 13 | -Vout | Common |
| 19 | +Vin (Vcc) | +Vin (Vcc) |
| 20 | +Vin (Vcc) | +Vin (Vcc) |

All specifications valid at nominal input voltage, full load and +25°C after warm-up time unless otherwise stated.

Solder Pad Dimensions mm (inches)



Specifications can be changed without notice